



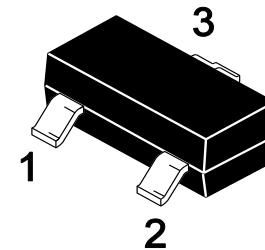
PJM60H12MNSA

N- Channel Depletion mode MOSFETs

Features

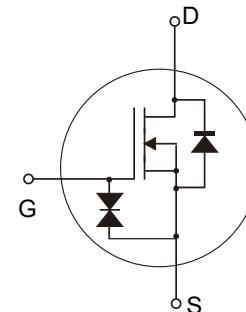
- ◆ Halogen and Antimony Free
- ◆ Depletion Mode
- ◆ ESD improved Capability

SOT-23



1.Gate 2.Source 3.Drain

Marking: F501D



Absolute Maximum Ratings

(T_c=25°C, unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V _{DSX}	600	V
Gate-Source Voltage	V _{GS}	±20	V
Continuous Drain Current	I _D	0.03	A
Continuous Drain Current T _c =70°C		0.024	
Pulsed Drain Current	I _{DM}	0.12	
Power Dissipation	P _D	0.5	W
Gate Source ESD (HBM-C=100pF, R=1.5kΩ)	V _{ESD(G-S)}	300	V
Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55 to 150	°C
Thermal Characteristics			
Parameter	Symbol	Typ.	Units
Maximum Junction-to-Ambient	R _{θJA}	250	°C/W



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Electrical Characteristics

($T_c=25^\circ\text{C}$, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
OFF Characteristics						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSX}}$	$V_{GS} = -5\text{V}, I_D = 250\mu\text{A}$	600	-	-	V
Gate Leakage Current	I_{GSS}	$V_{GS} = \pm 10\text{V}$	-	-	± 100	nA
Off-state Drain to Source Current	$I_{D(\text{off})}$	$V_{DS} = 600\text{V}, V_{GS} = -5\text{V}$	-	-	0.1	μA
		$V_{DS} = 480\text{V}, V_{GS} = -5\text{V}, T_a = 125^\circ\text{C}$	-	-	10	μA
ON Characteristics						
Gate Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = 3\text{V}, I_D = 8\mu\text{A}$	-2.7	-1.8	-1	V
On-state drain current	I_{DSS}	$V_{GS} = 0\text{V}, V_{DS} = 25\text{V}$	12	-	-	mA
Drain-Source On-Resistance	$R_{DS(\text{ON})}$	$V_{GS} = 0\text{V}, I_D = 3\text{mA}$	-	350	700	Ω
		$V_{GS} = 10\text{V}, I_D = 16\text{mA}$	-	400	800	
Dynamic Characteristics						
Forward transconductance	g_{fs}	$V_{DS} = 50\text{V}, I_D = 0.01\text{A}$	8	17	-	mS
Input Capacitance	C_{iss}	$V_{DS} = 25\text{V}, V_{GS} = -5\text{V}, f = 1\text{MHz}$	-	50	-	pF
Output Capacitance	C_{oss}		-	4.53	-	
Reverse Transfer Capacitance	C_{rss}		-	1.08	-	
Switching Characteristics						
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=300\text{V}, V_{GS}=-5\ldots 7\text{V}, R_G=6\Omega, I_D=0.01\text{A}$	-	9.9	-	ns
Turn-On Rise Time	t_r		-	55.8	-	
Turn-Off Delay Time	$t_{d(off)}$		-	56.4	-	
Turn-Off Fall Time	t_f		-	136	-	
Total Gate Charge	Q_g	$V_{DD}=400\text{V}, V_{GS}=-5\text{V to } 5\text{V}, I_D=0.01\text{A}$	-	1.14	-	nC
Gate-Source Charge	Q_{gs}		-	0.5	-	
Gate-Drain Charge	Q_{gd}		-	0.37	-	
Drain-source Diode Characteristics						
Diode Forward Current	I_s	$T_a=25^\circ\text{C}$	-	-	0.025	A
Pulse Diode Forward Current	I_{SM}		-	-	0.1	A
Forward Diode Voltage	V_{SD}	$V_{GS} = -5\text{V}, I_F = 16\text{mA}$	-	-	1.2	V
Gate-source Zener diode						
Gate-source breakdown voltage	V_{GS0}	$I_{GS} = \pm 1\text{mA}$ (Open Drain)	20	-	-	V



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Ratings And Characteristic Curves

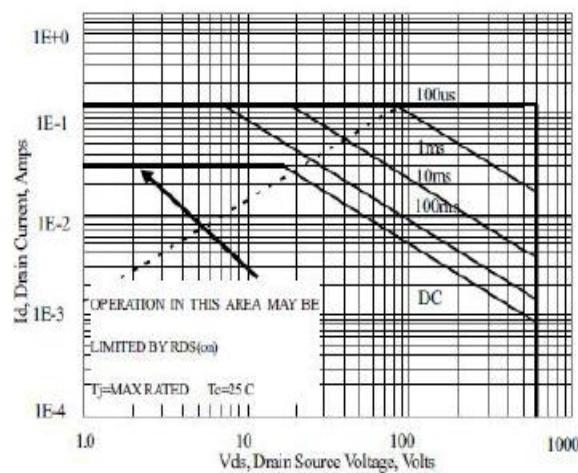


Figure 1 Maximum Forward Bias Safe Operating Area

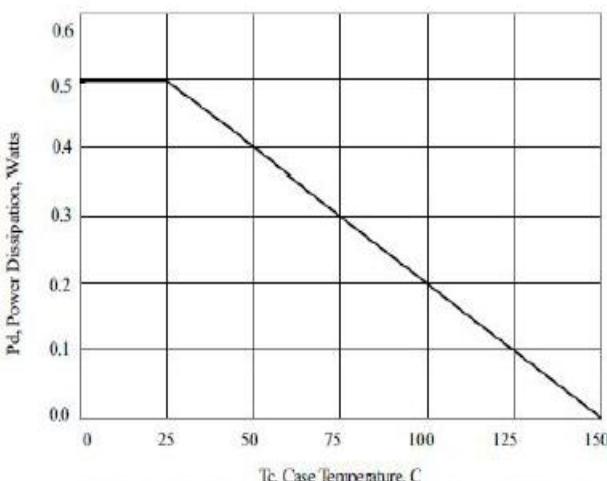


Figure 2 Maximum Power Dissipation vs Case Temperature

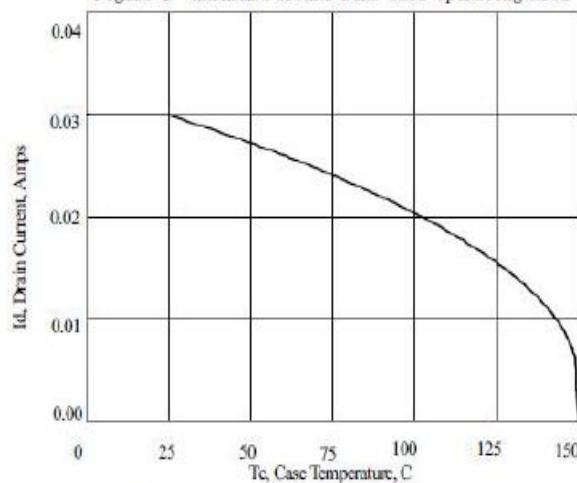


Figure 3 Maximum Continuous Drain Current vs Case Temperature

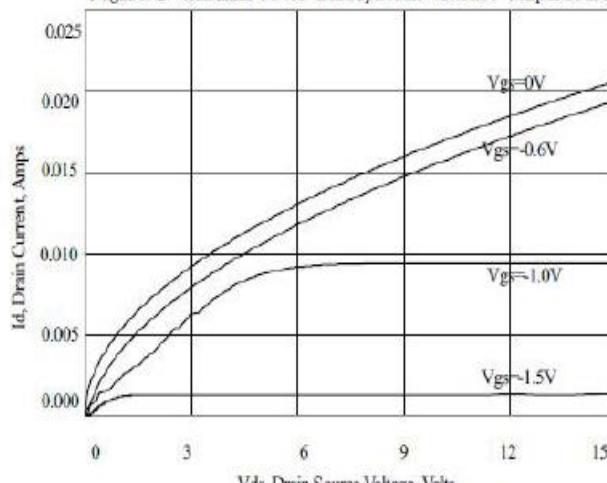


Figure 4 Typical Output Characteristics

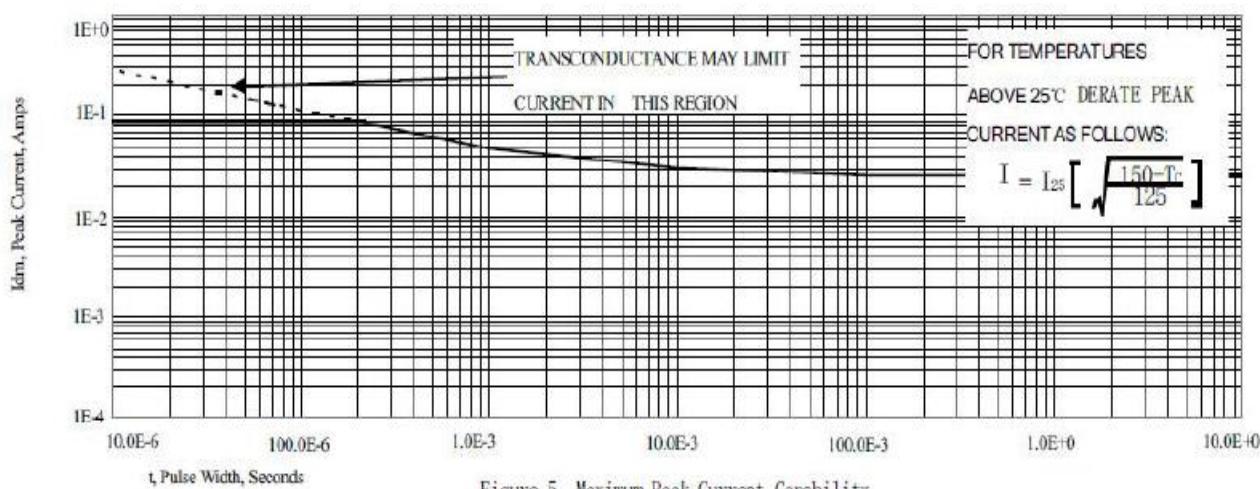


Figure 5 Maximum Peak Current Capability



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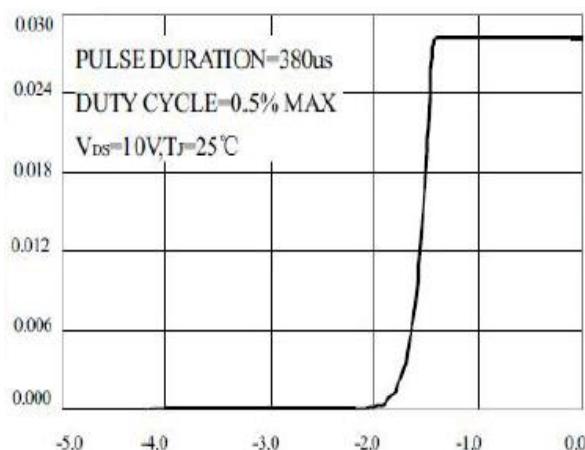


Figure 6 Typical Transfer Characteristics

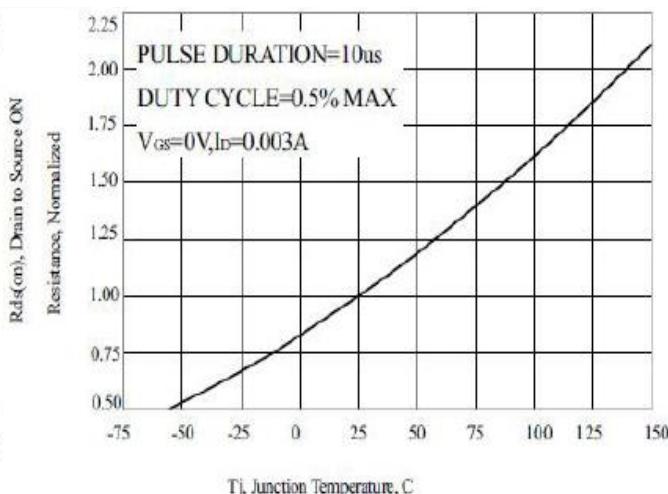


Figure 7 Typical Drain to Source ON Resistance vs Junction Temperature

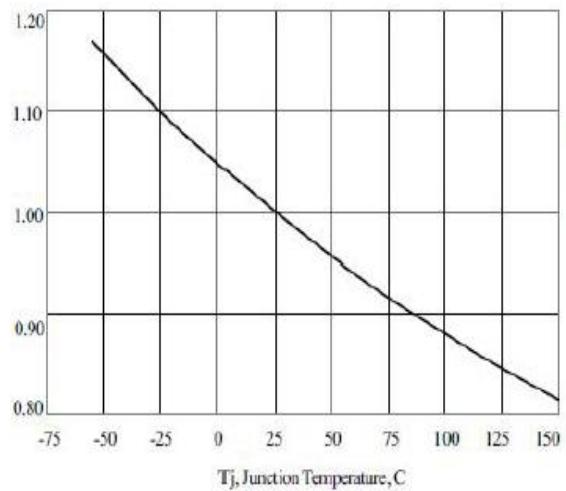


Figure 8 Typical Threshold Voltage vs Junction Temperature

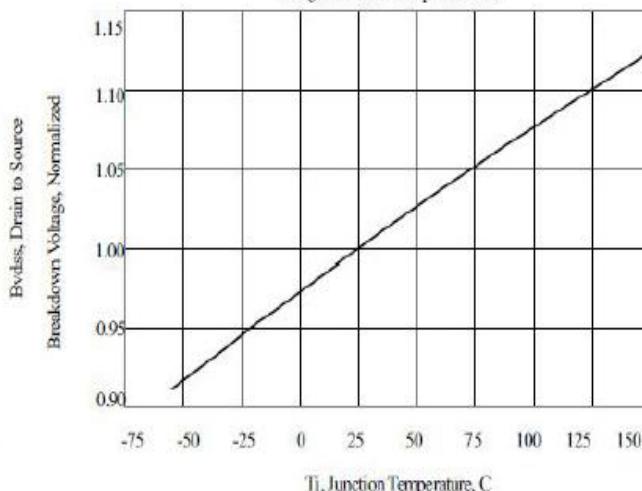


Figure 9 Typical Breakdown Voltage vs Junction Temperature

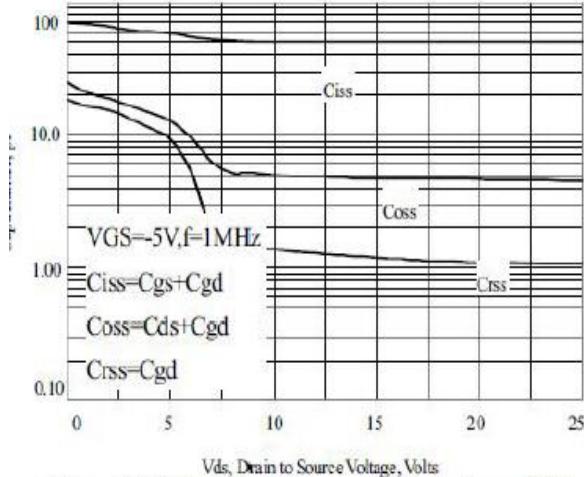


Figure 10 Typical Capacitance vs Drain to Source Voltage

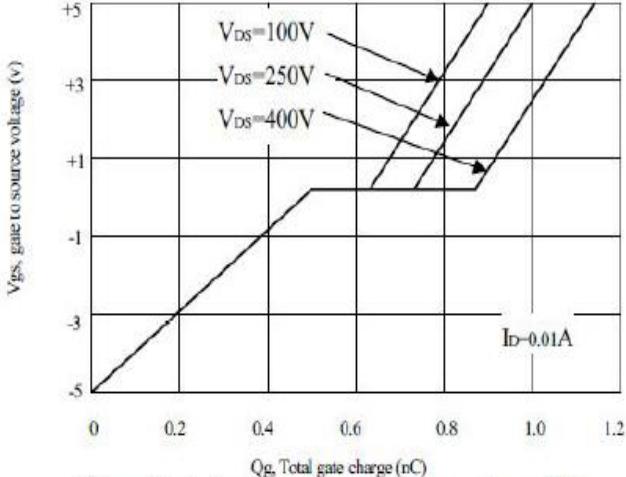


Figure 11 Typical Gate Charge vs Gate to Source Voltage



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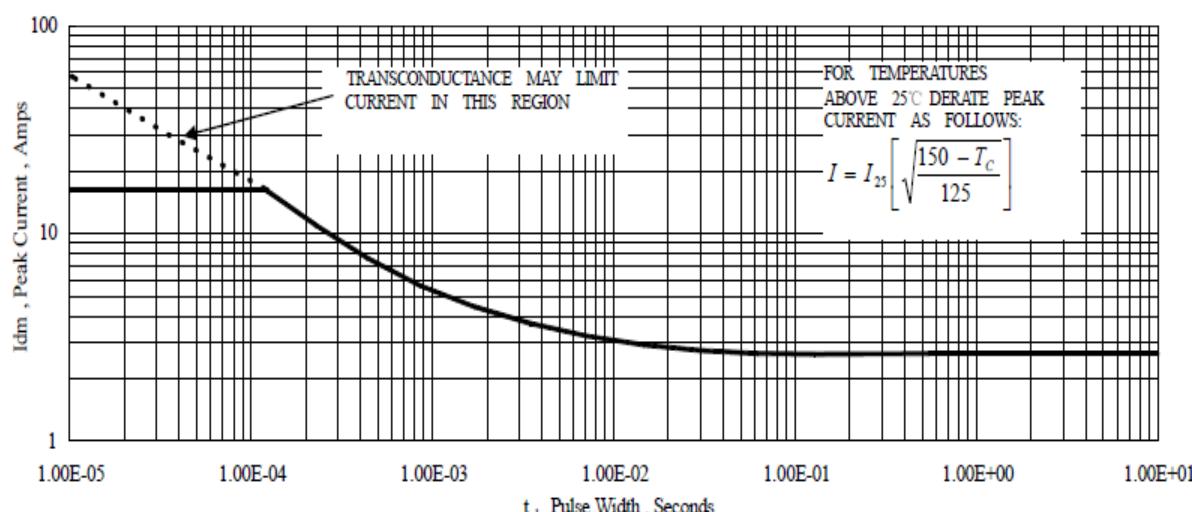


Figure 6 Maximum Peak Current Capability

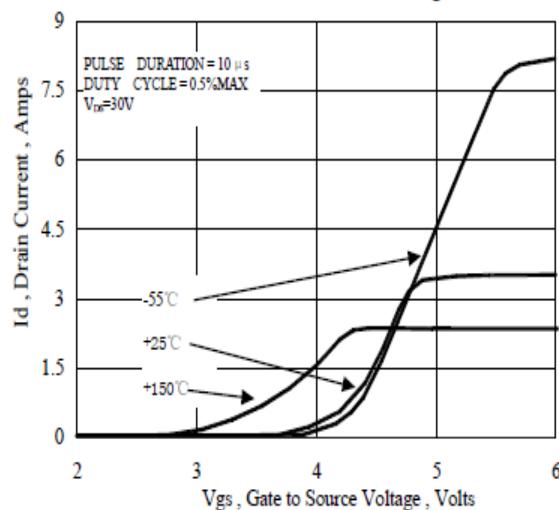


Figure 7 Typical Transfer Characteristics

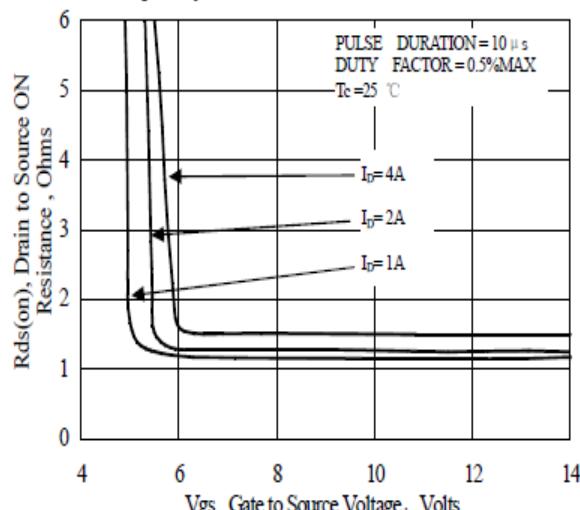


Figure 8 Typical Drain to Source ON Resistance vs Gate Voltage and Drain Current

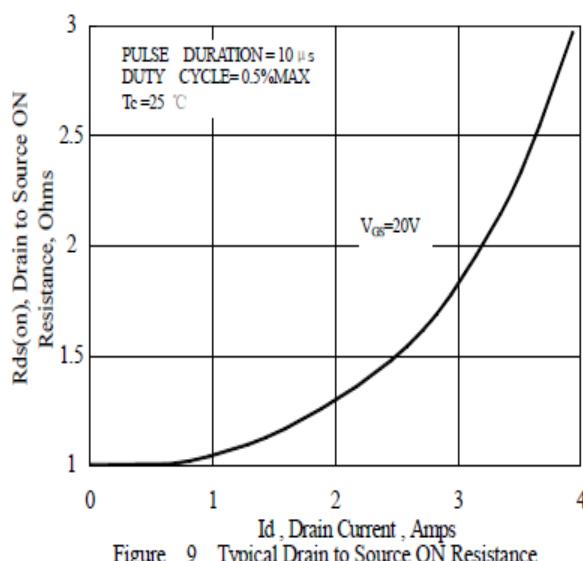


Figure 9 Typical Drain to Source ON Resistance vs Drain Current

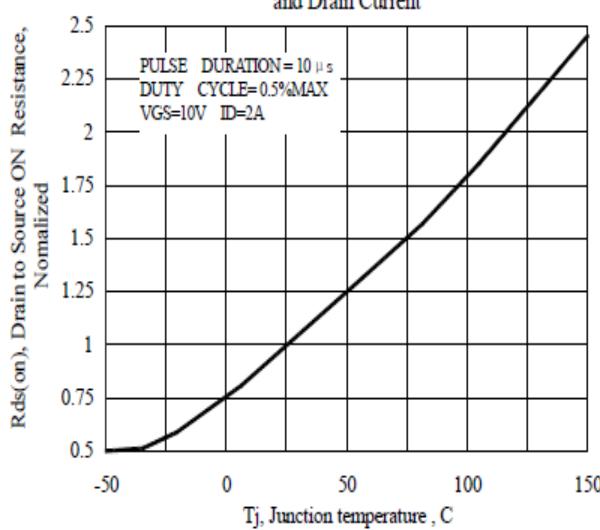
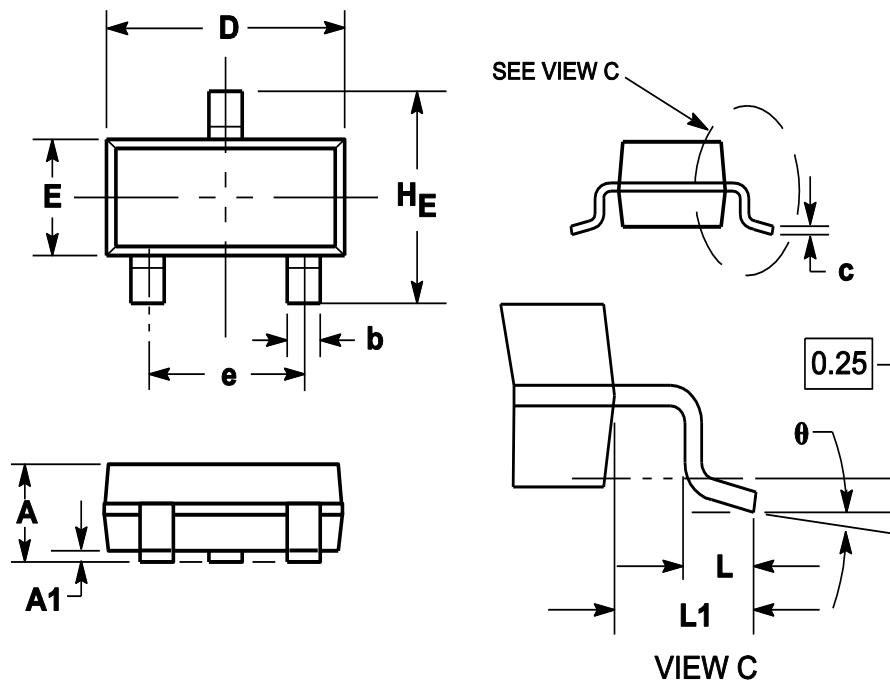


Figure 10 Typical Drain to Source ON Resistance vs Junction Temperature

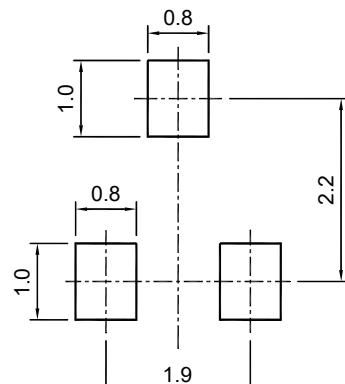


Package Outline

SOT-23



Symbol	Dimensions in millimeter		
	Min.	Typ.	Max.
A	0.900	1.025	1.150
A1	0.000	0.050	0.100
b	0.300	0.400	0.500
c	0.080	0.115	0.150
D	2.800	2.900	3.000
E	1.200	1.300	1.400
HE	2.250	2.400	2.550
e	1.800	1.900	2.000
L1	0.550REF		
L	0.300		0.500
theta	0°		8°



SOT-23
Recommended soldering pad

Ordering Information

Device	Package	Shipping
PJM60H12MNSA	SOT-23	3000/Reel&Tape(7inch)